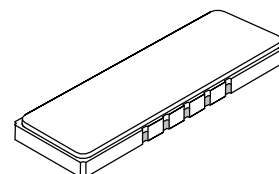


SF1194A

167 MHz SAW Filter



SMP-75

- **Low Insertion Loss**
- **Excellent Size-to-Performance Ratio**
- **Hermetic SMP-75 Surface-Mount Case**
- **Single-Ended or Differential Input and Output**
- **Complies with Directive 2002/95/EC (RoHS)**



Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Temperature Range	-5 to +85	°C
Suitable for lead-free soldering - Max. Soldering Profile	260°C for 30 s	

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	f_O	1	167			MHz
Maximum Insertion Loss 167 \pm .075 MHz	IL				7.0	dB
2.0 dB Bandedges					\pm .200	MHz
17 dB Bandedges					\pm .400	MHz
36 dB Bandedges					\pm .600	MHz
41 dB Bandedges					\pm .800	MHz
Ultimate Rejection						
30 to 147 MHz			70			dB
147 to 165.4 MHz			41			dB
168.6 to 187 MHz			41			dB
187 to 276 MHz			70			dB
276 to 278 MHz			50			dB
278 to 2000 MHz			70			dB
Amplitude Variation					1.5	dB p-p
Amplitude Ripple					1	dB p-p
Absolute Group Delay				2.3	2.6	μ sec
Group Delay Variation					400	nsec
Maximum RF Input Power					22	dBm
Input IMR		For two -20dBm input signals At 167 + .800 MHz And 167 + 1.600 MHz Or at 167 -.800 MHz And 167 -1.600 MHz	100			dB
Input Return Loss			15			dB
Output Return Loss			10			dB
Source/Load Impedance	Single-Ended or Differential Input / Output					Ohm
Matching Components	Fixed value, external Q 40-50					
Case Style			SMP-75 19 x 6.5 mm Nominal Footprint			
Lid Symbolization (YY = year, WW = week)		4	RFM SF1194A YYWW			

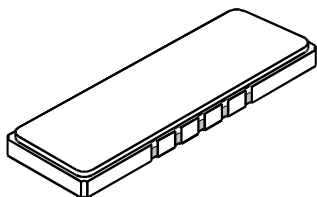
NOTES:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
3. The design, manufacturing process, and specifications of this filter are subject to change.
4. Tape and Reel Standard ANSI / EIA 481.
5. US and international patents may apply.
6. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd
7. Electrostatic Sensitive Device. Observe precautions for handling.



SMP-75 Case

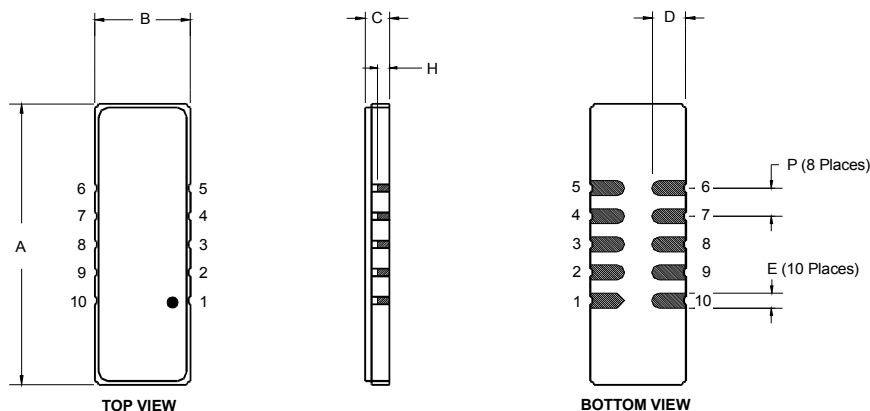
10-Terminal Ceramic Surface-Mount Case 19 x 6.5 mm Nominal Footprint



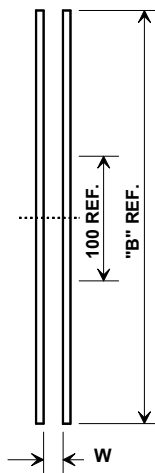
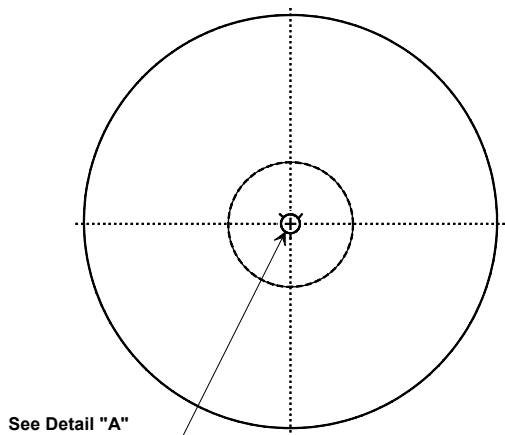
Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	18.80	19.00	19.30	0.740	0.748	0.760
B	6.30	6.50	6.80	0.248	0.256	0.268
C		1.75	2.00		0.069	0.079
D		2.29			0.090	
E		1.02			0.040	
H		1.0			0.039	
P		1.905			0.075	

Materials	
Solder Pad Termination	Au plating 30 - 60 μ inches (76.2-152 μ m) over 80-200 μ inches (203-508 μ m) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 μ inches Thick
Body	Al ₂ O ₃ Ceramic
Pb Free	

Electrical Connections		
Connection		Terminals
Port 1	Input or Return	10
	Return or Input	1
Port 2	Output or Return	5
	Return or Output	6
Ground		All others
Single Ended Operation		Return is ground
Differential Operation		Return is hot



Tape and Reel Specifications

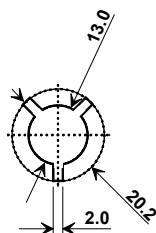


Tape and Reel Packaging with the following conditions:

Tape Width: 32 mm

Tape Pitch (part to part): 12 mm

Component Orientation: Parts shall be oriented with the narrow side closest to the tape's round sprocket holes on the tape's trailing edge.

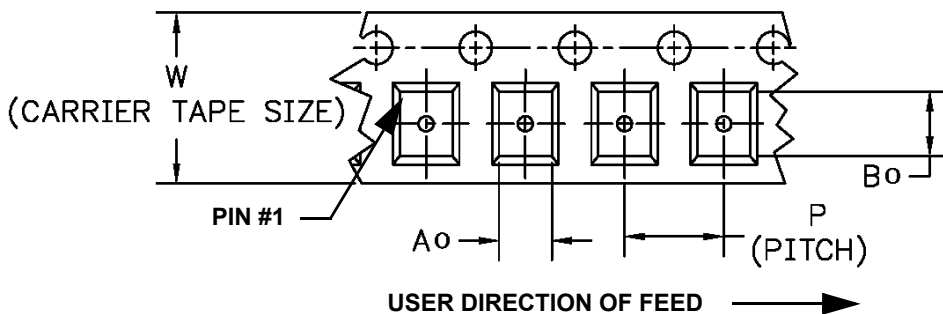
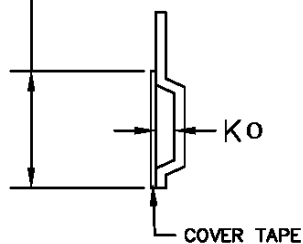


"B "		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	1000

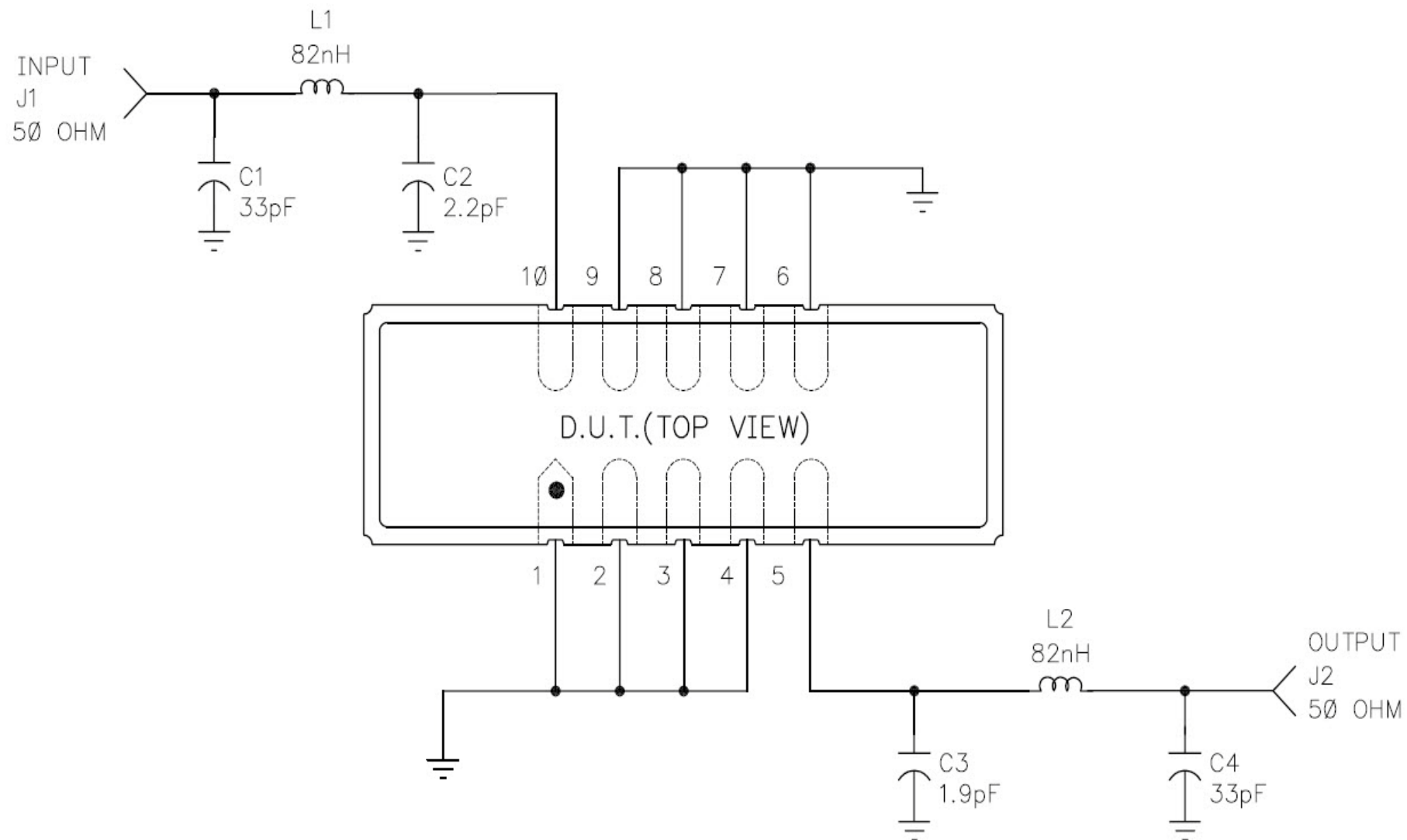
COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions		Cover Tape
Ao	.276 ± .004 (7.01)	25.5 mm
Bo	.768 ± .004 (19.51)	
Ko	.088 ± .004 (2.24)	
Pitch	12mm	
W	32mm	

COVER TAPE SIZE



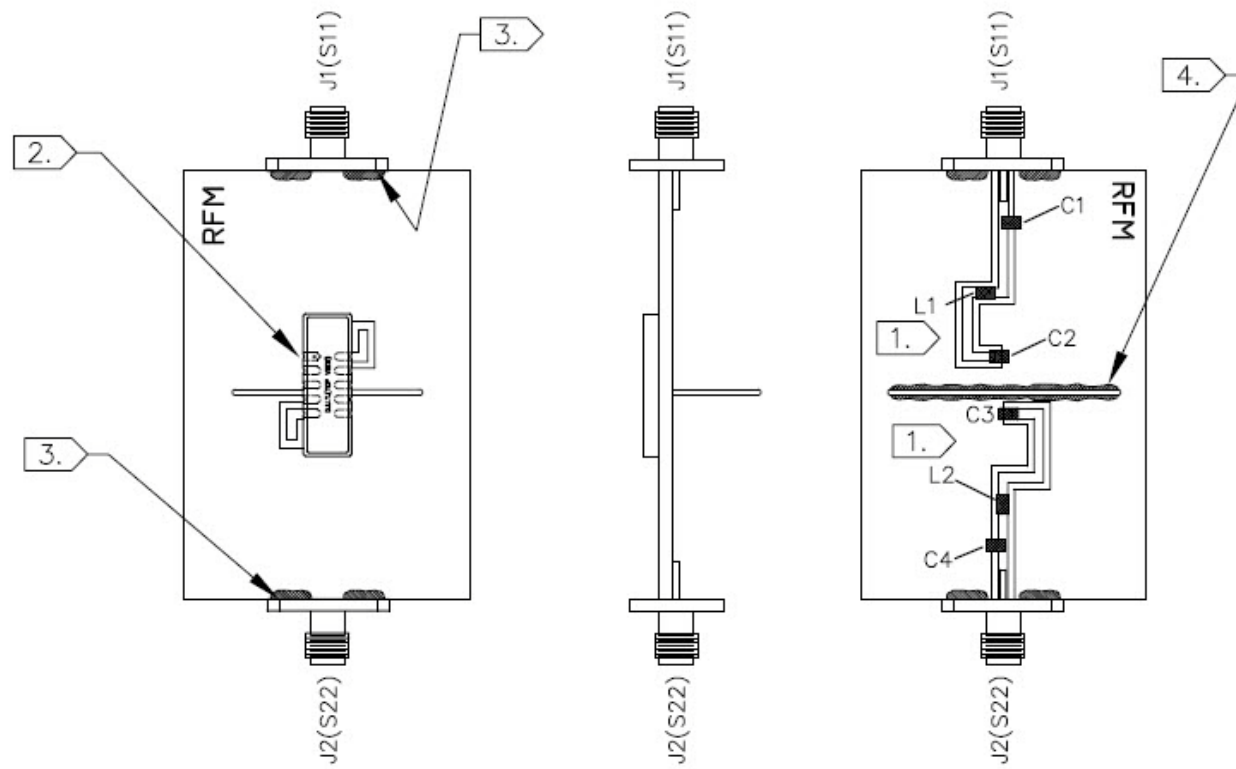
Assembly Diagram



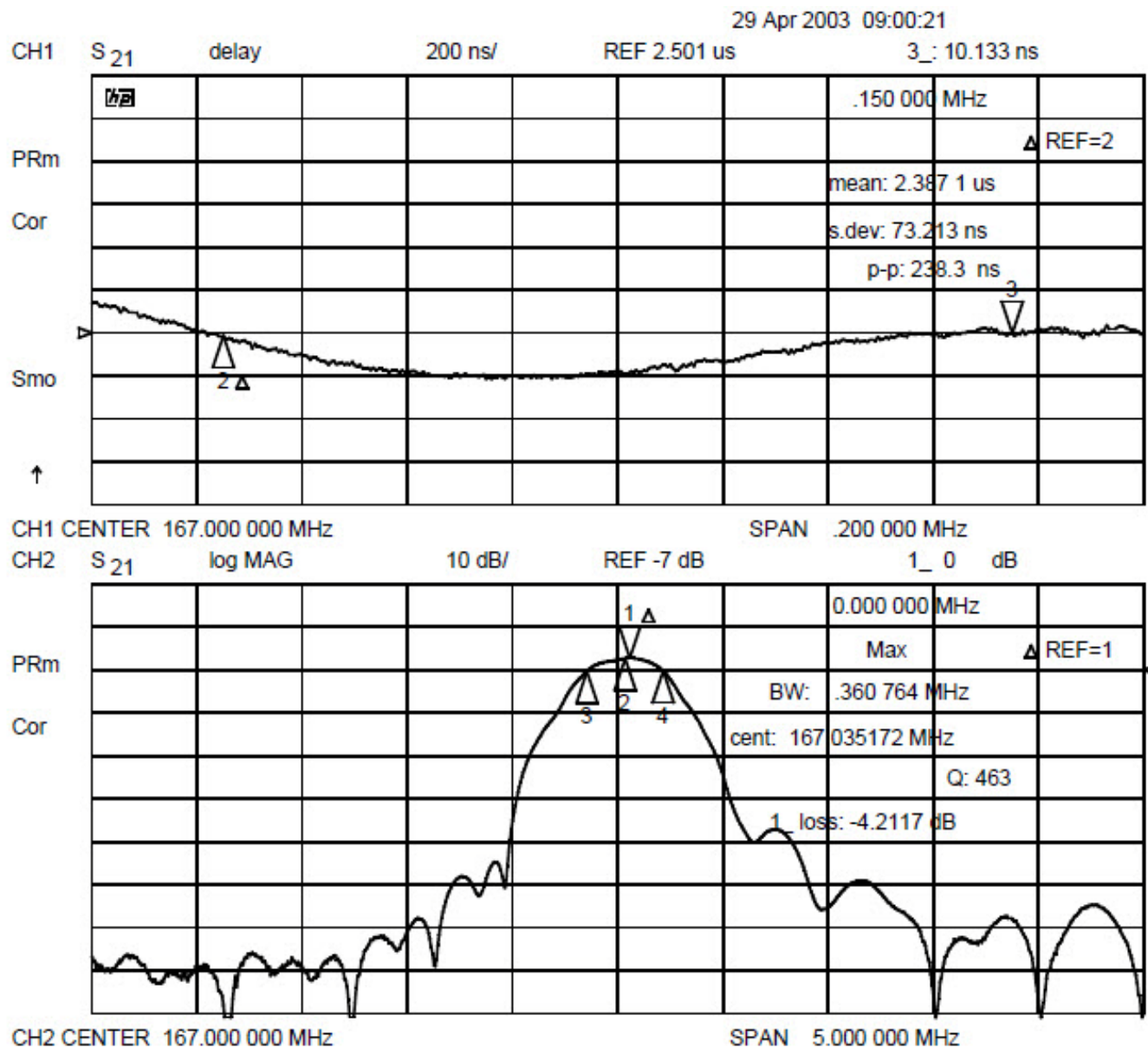
Inductor Pairs

NOTES:

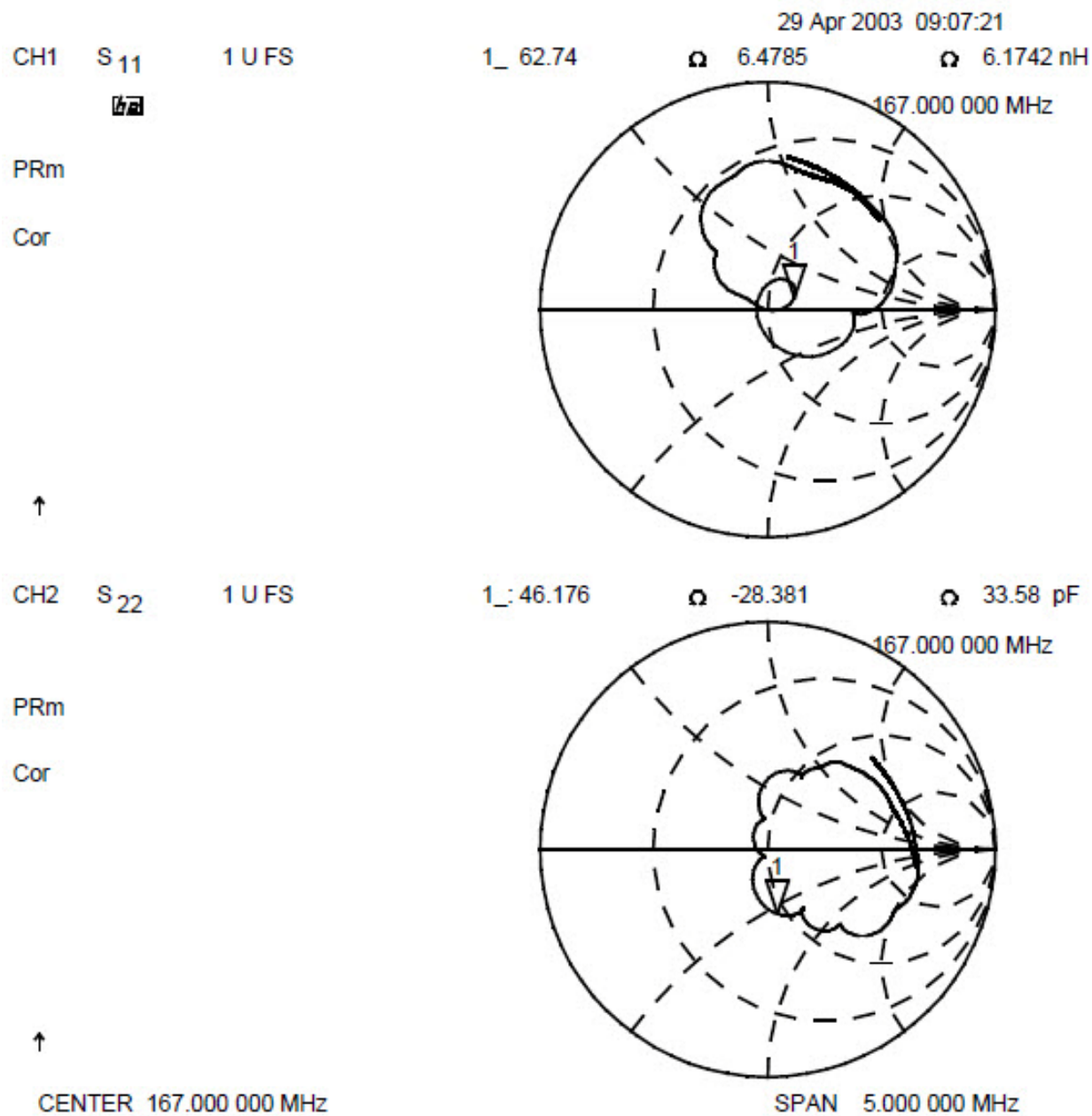
1. NOTE PROPER ORIENTATION OF INDUCTOR PAIRS L1 & L2. THEY ARE TO BE POSITIONED 90° TO EACH OTHER.
2. SOLDER SURFACE MOUNT PACKAGE TO TEST SIDE OF PCB. SOLDER 10 PLACES AS SHOWN. NOTE PIN 1 INDICATOR.
3. SOLDER CONNECTOR FLANGES ON BOTH SIDES OF PCB.
4. SOLDER SHIELD AS SHOWN.



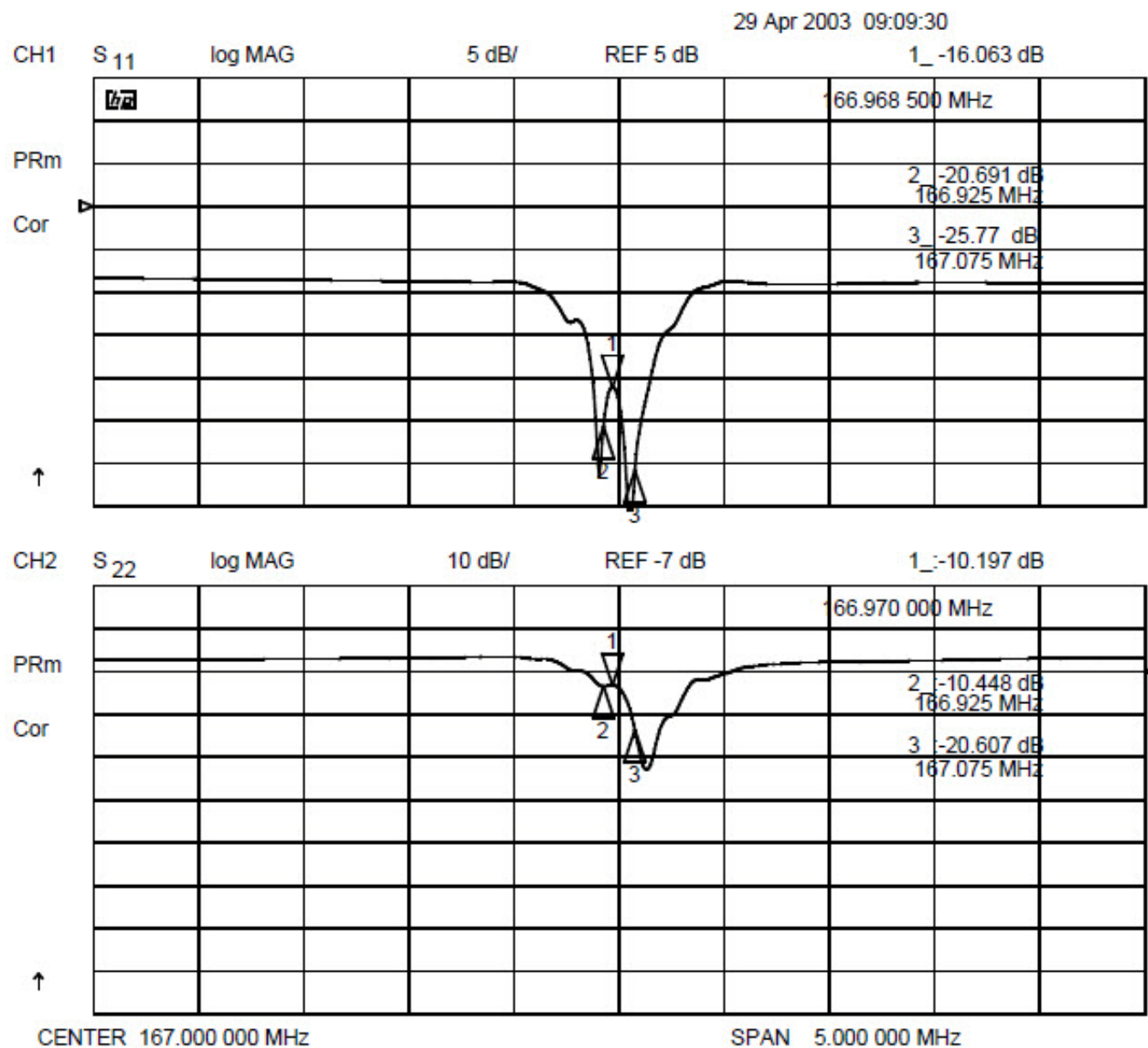
Frequency Characteristics



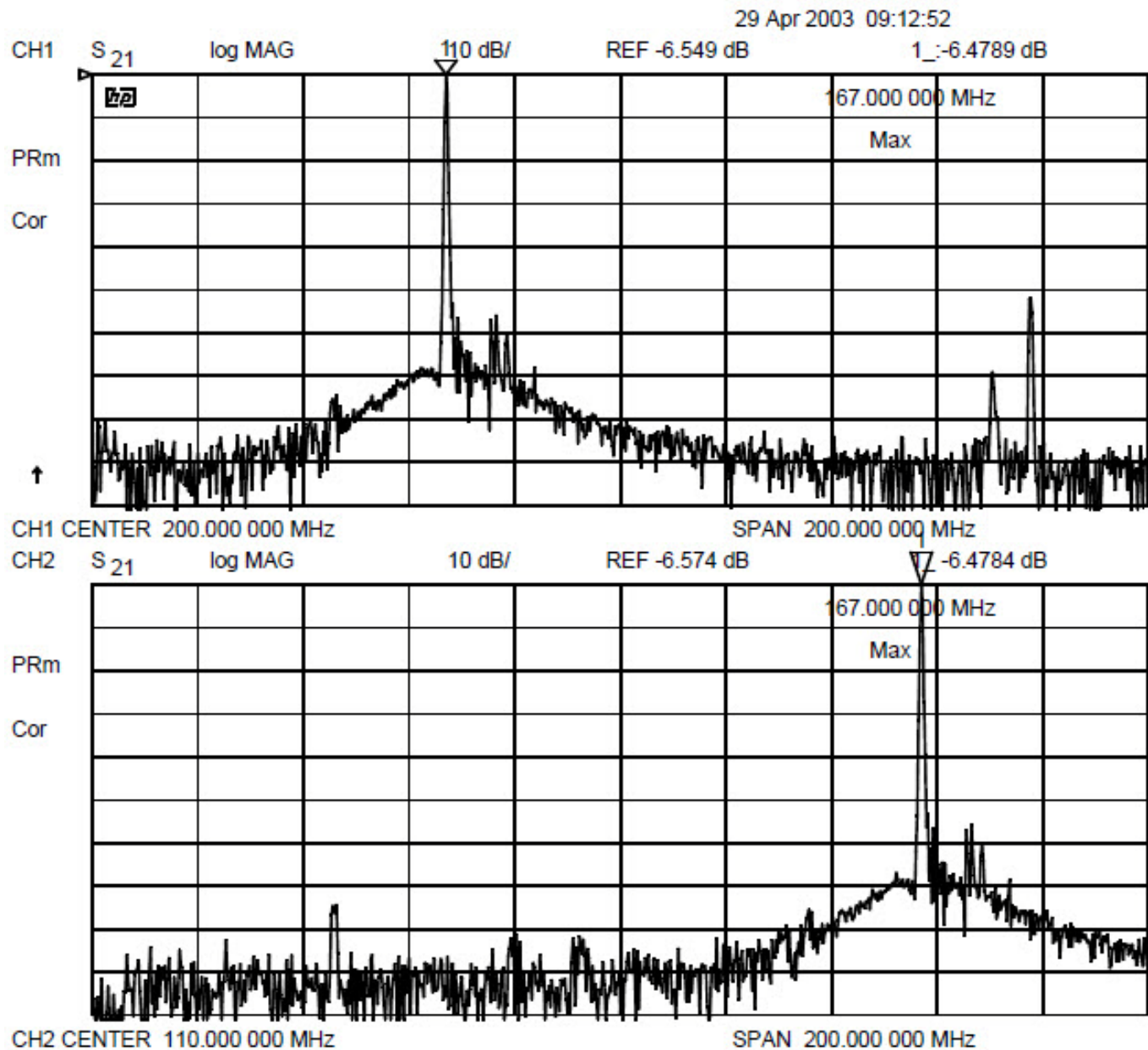
Frequency Characteristics



Frequency Characteristics



Frequency Characteristics



Frequency Characteristics

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